

2SA2079

Silicon PNP epitaxial planar type

For general amplification
Complementary to 2SC5848

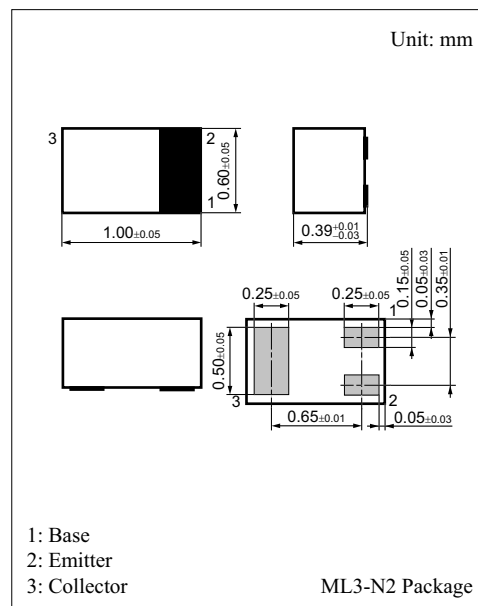
■ Features

- High forward current transfer ratio h_{FE}
- Suitable for high-density mounting and downsizing of the equipment for ultraminiature leadless package

Package: 0.6 mm × 1.0 mm (height 0.39 mm)

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|-----------|-------------|------------------|
| Collector-base voltage (Emitter open) | V_{CBO} | -45 | V |
| Collector-emitter voltage (Base open) | V_{CEO} | -45 | V |
| Emitter-base voltage (Collector open) | V_{EBO} | -7 | V |
| Collector current | I_C | -100 | mA |
| Peak collector current | I_{CP} | -200 | mA |
| Collector power dissipation | P_C | 100 | mW |
| Junction temperature | T_j | 125 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -55 to +125 | $^\circ\text{C}$ |

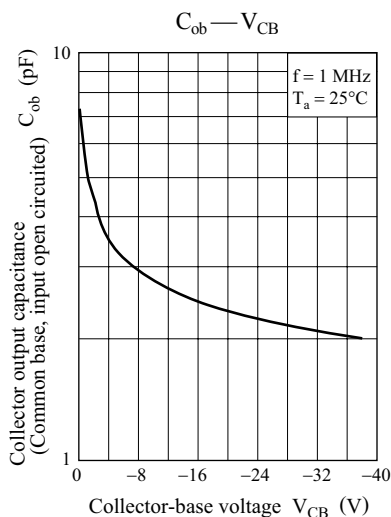
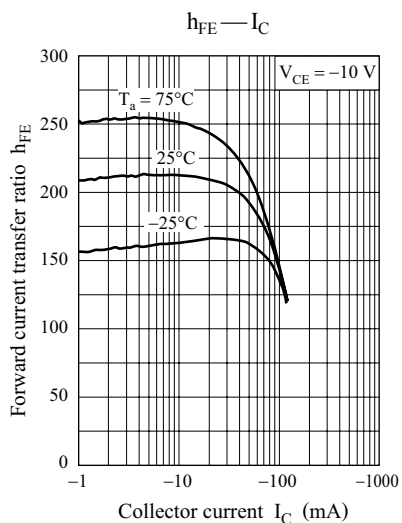
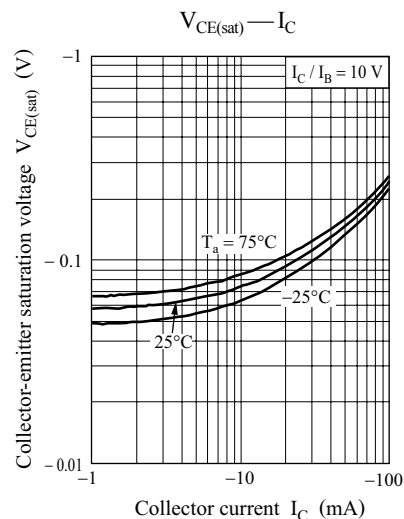
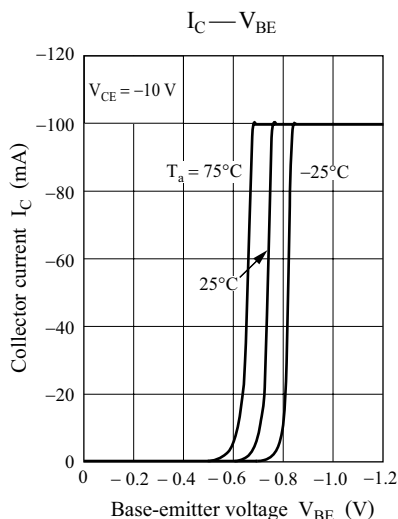
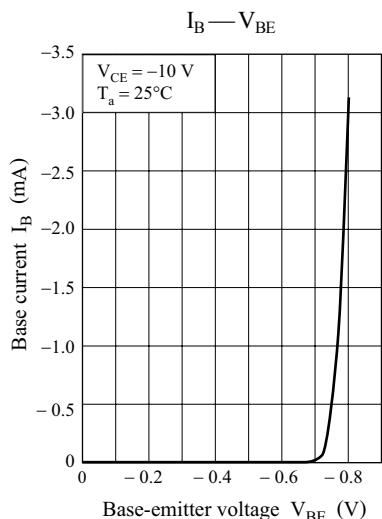
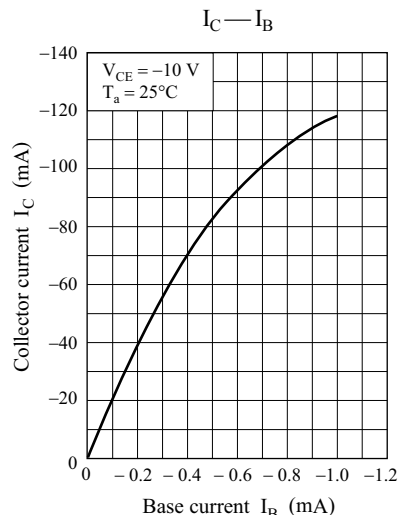
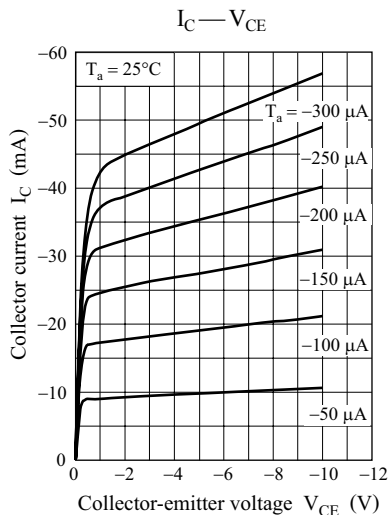
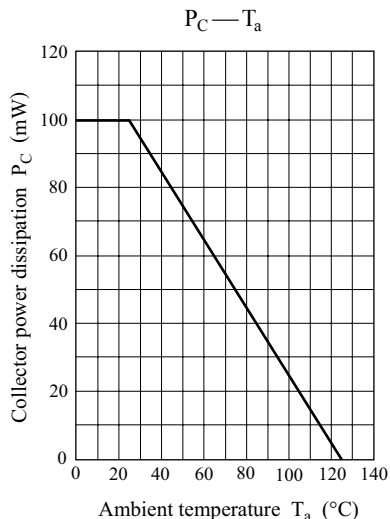


Marking Symbol : 3D

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|---|---------------|---|-----|------|------|---------------|
| Collector-base voltage (Emitter open) | V_{CBO} | $I_C = -10 \mu\text{A}, I_E = 0$ | -45 | | | V |
| Collector-emitter voltage (Base open) | V_{CEO} | $I_C = -2 \text{ mA}, I_B = 0$ | -45 | | | V |
| Emitter-base voltage (Collector open) | V_{EBO} | $I_E = -10 \mu\text{A}, I_C = 0$ | -7 | | | V |
| Collector-base cutoff current (Emitter open) | I_{CBO} | $V_{CB} = -20 \text{ V}, I_E = 0$ | | | -0.1 | μA |
| Collector-emitter cut-off current (Base open) | I_{CEO} | $V_{CE} = -10 \text{ V}, I_B = 0$ | | | -100 | μA |
| Forward current transfer ratio | h_{FE} | $V_{CE} = -10 \text{ V}, I_C = -2 \text{ mA}$ | 180 | | 390 | — |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$ | | -0.2 | -0.5 | V |
| Transition frequency | f_T | $V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$ | | 80 | | MHz |
| Collector output capacitance (Common base, input open circuited) | C_{ob} | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | 2.2 | | pF |

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



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